



PMEG4005AESF

40 V, 0.5 A low VF MEGA Schottky barrier rectifier

6 February 2015

Product data sheet

1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection in a DSN0603-2 (SOD962-2) leadless ultra small Chip-Scale Package (CSP).

2. Features and benefits

- Average forward current $I_{F(AV)} \leq 0.5$ A
- Reverse voltage $V_R \leq 40$ V
- Low forward voltage typ. $V_F = 250$ mV
- Low reverse current typ. $I_R = 3$ μ A
- Package height typ. 0.3 mm

3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch Mode Power Supply (SMPS)
- Ultra high speed switching
- LED backlight for mobile application

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$; $f = 20$ kHz; $T_{amb} \leq 100$ °C; square wave	[1]	-	-	0.5	A
		$\delta = 0.5$; $f = 20$ kHz; $T_{sp} \leq 140$ °C; square wave		-	-	0.5	A
V_R	reverse voltage	$T_j = 25$ °C		-	-	40	V
V_F	forward voltage	$I_F = 10$ mA; $t_p \leq 300$ μ s; $\delta \leq 0.02$; $T_j = 25$ °C		-	250	320	mV
I_R	reverse current	$V_R = 10$ V; $T_j = 25$ °C; pulsed		-	3	20	μ A
t_{rr}	reverse recovery time	$I_F = 500$ mA; $I_R = 500$ mA; $I_{R(meas)} = 100$ mA; $T_j = 25$ °C		-	1.25	-	ns

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al_2O_3 , standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	 Transparent top view DSN0603-2 (SOD962-2)	 1 2 <i>sym001</i>
2	A	anode		

[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG4005AESF	DSN0603-2	Leadless ultra small package; 2 terminals; body 0.6 x 0.3 x 0.3 mm	SOD962-2

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG4005AESF	Z

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_R	reverse voltage	$T_j = 25\text{ }^{\circ}\text{C}$		-	40	V
I_F	forward current	$T_{sp} \leq 138\text{ }^{\circ}\text{C}$; $\delta = 1$		-	0.71	A
$I_{F(AV)}$	average forward current	$\delta = 0.5$; $f = 20\text{ kHz}$; $T_{amb} \leq 100\text{ }^{\circ}\text{C}$; square wave	[1]	-	0.5	A
		$\delta = 0.5$; $f = 20\text{ kHz}$; $T_{sp} \leq 140\text{ }^{\circ}\text{C}$; square wave		-	0.5	A
I_{FRM}	repetitive peak forward current	$t_p = 1\text{ ms}$; $\delta \leq 0.25$		-	1.2	A
I_{FSM}	non-repetitive peak forward current	$t_p = 8\text{ ms}$; $T_{j(init)} = 25\text{ }^{\circ}\text{C}$; square wave		-	3.5	A
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ }^{\circ}\text{C}$	[2]	-	405	mW
			[3]	-	660	mW
			[1]	-	1200	mW
T_j	junction temperature			-	150	$^{\circ}\text{C}$
T_{amb}	ambient temperature			-55	150	$^{\circ}\text{C}$
T_{stg}	storage temperature			-65	150	$^{\circ}\text{C}$

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al_2O_3 , standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode and cathode 1 cm^2 each.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1][2]	-	-	310	K/W
			[1][3]	-	-	190	K/W
			[1][4]	-	-	105	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[5]	-	-	40	K/W

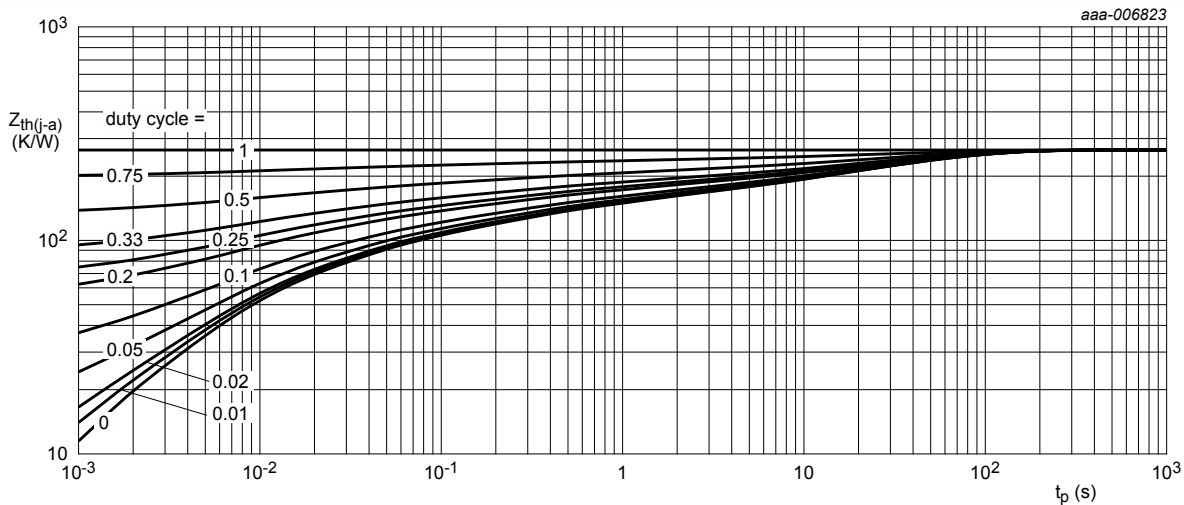
[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for anode and cathode 1 cm^2 each.

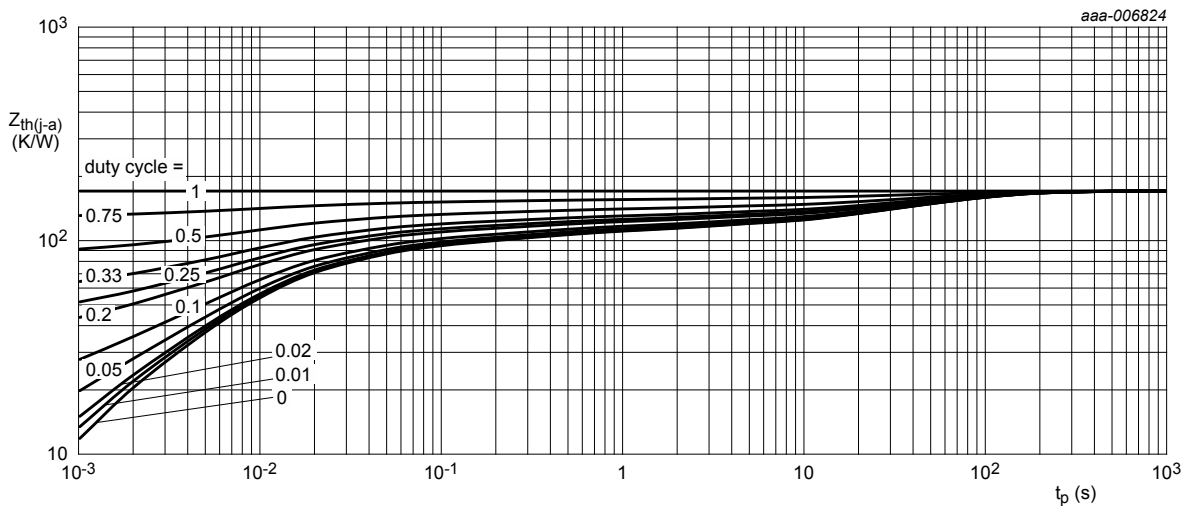
[4] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[5] Soldering point of anode tab.



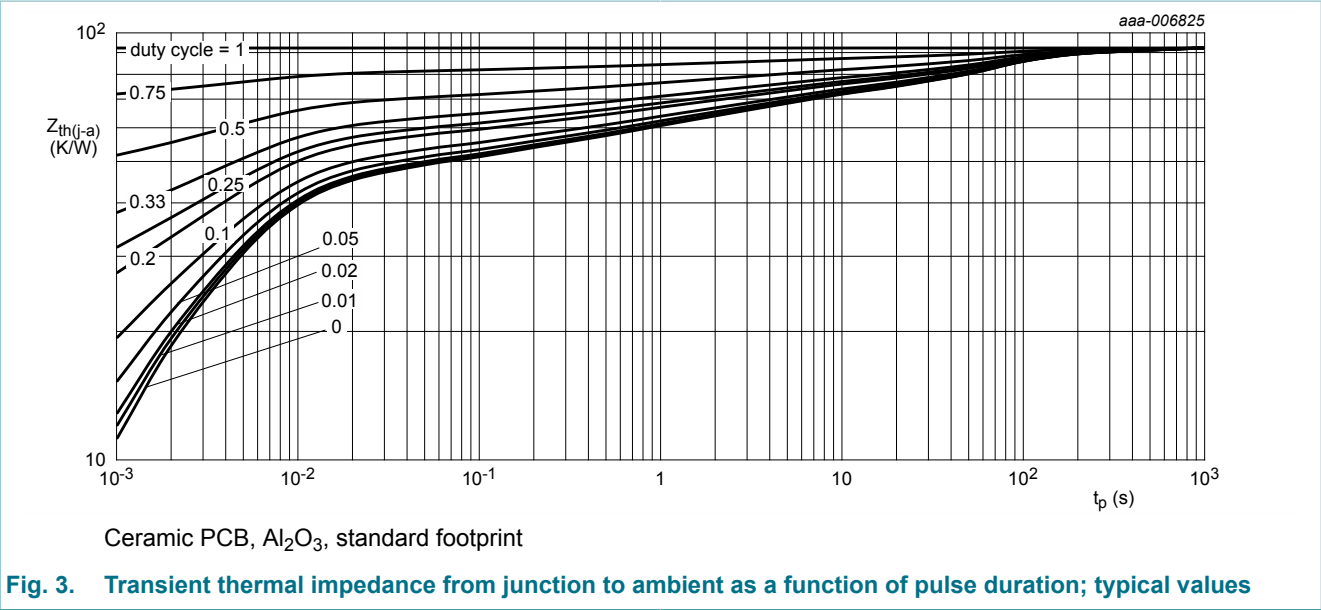
FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for anode and cathode 1 cm² each

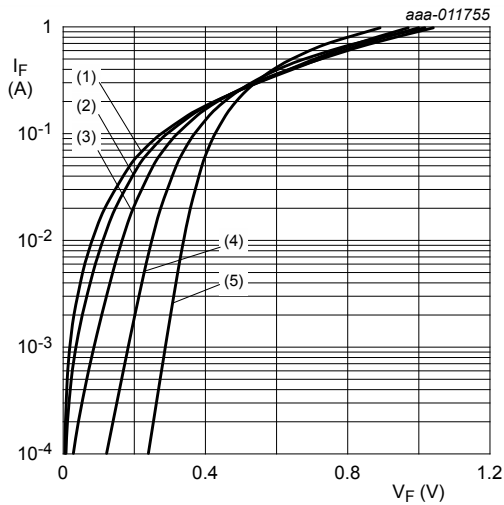
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



10. Characteristics

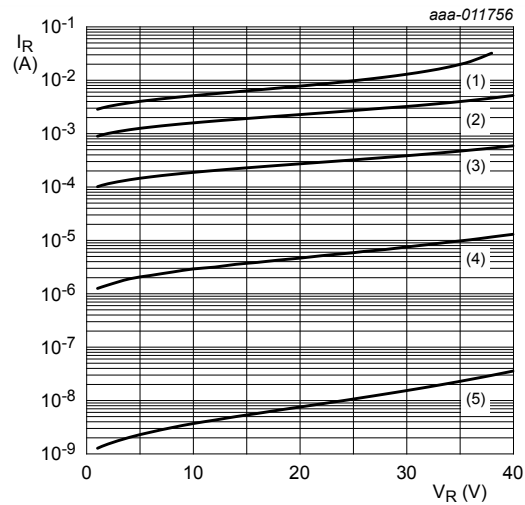
Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 100 \mu A$; $t_p = 300 \mu s$; $\delta = 0.02$; $T_j = 25^\circ C$	40	-	-	V
V_F	forward voltage	$I_F = 0.1 \text{ mA}$; $t_p \leq 300 \mu s$; $\delta \leq 0.02$; $T_j = 25^\circ C$	-	120	185	mV
		$I_F = 1 \text{ mA}$; $t_p \leq 300 \mu s$; $\delta \leq 0.02$; $T_j = 25^\circ C$	-	180	245	mV
		$I_F = 10 \text{ mA}$; $t_p \leq 300 \mu s$; $\delta \leq 0.02$; $T_j = 25^\circ C$	-	250	320	mV
		$I_F = 100 \text{ mA}$; $t_p \leq 300 \mu s$; $\delta \leq 0.02$; $T_j = 25^\circ C$	-	370	440	mV
		$I_F = 200 \text{ mA}$; $t_p \leq 300 \mu s$; $\delta \leq 0.02$; $T_j = 25^\circ C$	-	450	525	mV
		$I_F = 300 \text{ mA}$; $t_p \leq 300 \mu s$; $\delta \leq 0.02$; $T_j = 25^\circ C$	-	530	630	mV
		$I_F = 400 \text{ mA}$; $t_p \leq 300 \mu s$; $\delta \leq 0.02$; $T_j = 25^\circ C$	-	600	730	mV
		$I_F = 500 \text{ mA}$; $t_p \leq 300 \mu s$; $\delta \leq 0.02$; $T_j = 25^\circ C$	-	675	820	mV
I_R	reverse current	$V_R = 10 \text{ V}$; $T_j = 25^\circ C$; pulsed	-	3	20	μA
		$V_R = 40 \text{ V}$; $T_j = 25^\circ C$; pulsed	-	13	80	μA
C_d	diode capacitance	$V_R = 1 \text{ V}$; $f = 1 \text{ MHz}$; $T_j = 25^\circ C$	-	18	-	pF
		$V_R = 10 \text{ V}$; $f = 1 \text{ MHz}$; $T_j = 25^\circ C$	-	7	-	pF
t_{rr}	reverse recovery time	$I_F = 500 \text{ mA}$; $I_R = 500 \text{ mA}$; $I_{R(\text{meas})} = 100 \text{ mA}$; $T_j = 25^\circ C$	-	1.25	-	ns



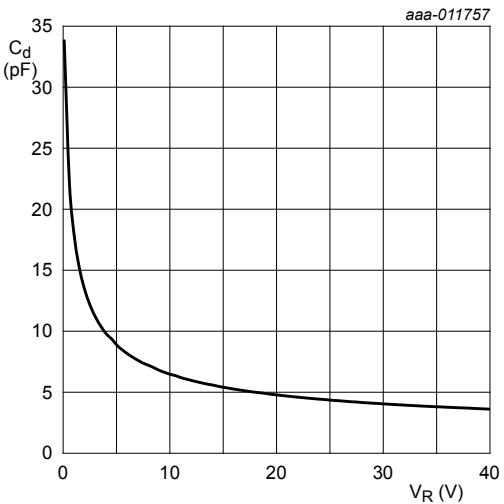
pulsed condition
(1) $T_j = 150^\circ\text{C}$
(2) $T_j = 125^\circ\text{C}$
(3) $T_j = 85^\circ\text{C}$
(4) $T_j = 25^\circ\text{C}$
(5) $T_j = -40^\circ\text{C}$

Fig. 4. Forward current as a function of forward voltage; typical values



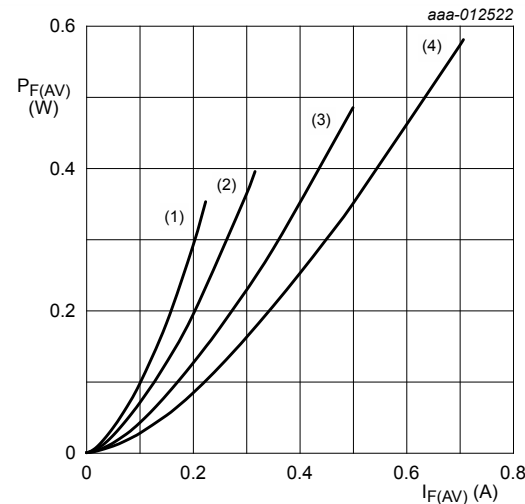
pulsed condition
(1) $T_j = 150^\circ\text{C}$
(2) $T_j = 125^\circ\text{C}$
(3) $T_j = 85^\circ\text{C}$
(4) $T_j = 25^\circ\text{C}$
(5) $T_j = -40^\circ\text{C}$

Fig. 5. Reverse current as a function of reverse voltage; typical values



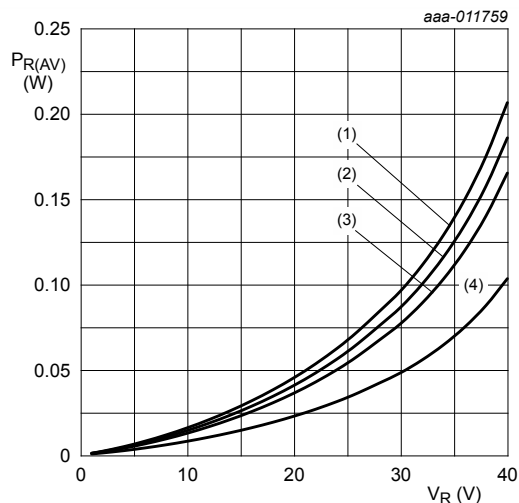
$f = 1\text{ MHz}$; $T_{\text{amb}} = 25^\circ\text{C}$

Fig. 6. Diode capacitance as a function of reverse voltage; typical values



$T_j = 150^\circ\text{C}$
(1) $\delta = 0.1$
(2) $\delta = 0.2$
(3) $\delta = 0.5$
(4) $\delta = 1$

Fig. 7. Average forward power dissipation as a function of average forward current; typical values



$T_j = 125\text{ }^{\circ}\text{C}$

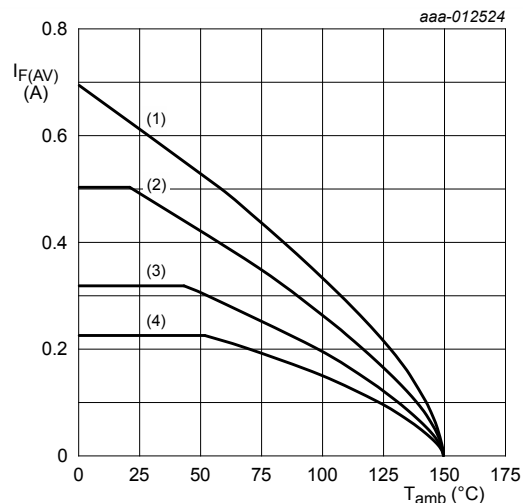
(1) $\delta = 1$

(2) $\delta = 0.9$

(3) $\delta = 0.8$

(4) $\delta = 0.5$

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

$T_j = 150\text{ }^{\circ}\text{C}$

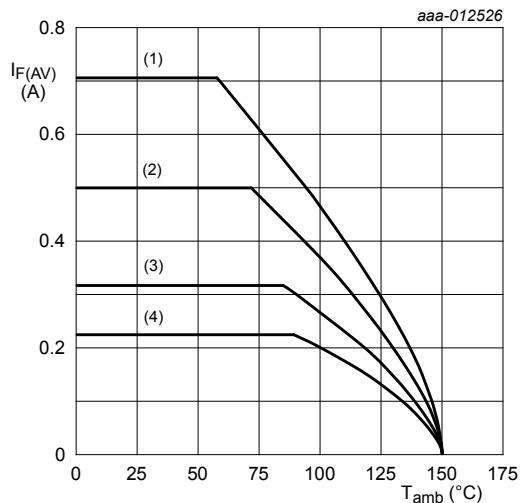
(1) $\delta = 1$; DC

(2) $\delta = 0.5$; $f = 20\text{ kHz}$

(3) $\delta = 0.2$; $f = 20\text{ kHz}$

(4) $\delta = 0.1$; $f = 20\text{ kHz}$

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for anode and cathode 1 cm^2 each

$T_j = 150\text{ }^{\circ}\text{C}$

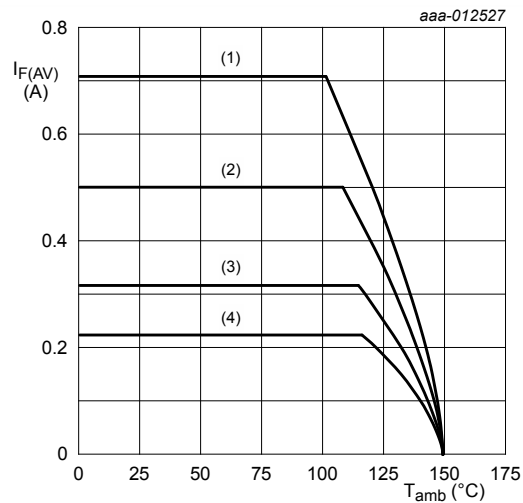
(1) $\delta = 1$; DC

(2) $\delta = 0.5$; $f = 20\text{ kHz}$

(3) $\delta = 0.2$; $f = 20\text{ kHz}$

(4) $\delta = 0.1$; $f = 20\text{ kHz}$

Fig. 10. Average forward current as a function of solder point temperature; typical values



Ceramic PCB, Al_2O_3 , standard footprint

$T_j = 150\text{ }^{\circ}\text{C}$

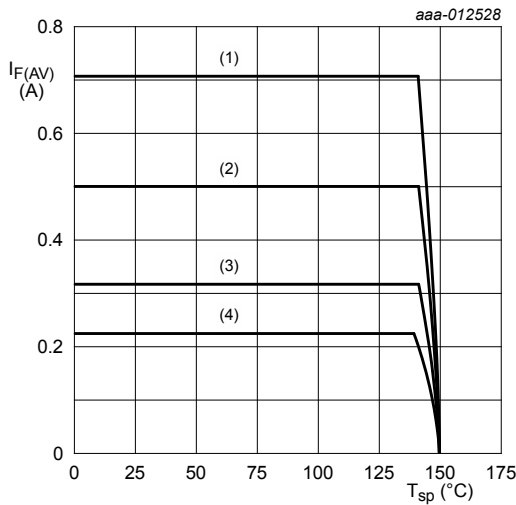
(1) $\delta = 1$; DC

(2) $\delta = 0.5$; $f = 20\text{ kHz}$

(3) $\delta = 0.2$; $f = 20\text{ kHz}$

(4) $\delta = 0.1$; $f = 20\text{ kHz}$

Fig. 11. Average forward current as a function of ambient temperature; typical values



$T_J = 150\text{ }^{\circ}\text{C}$
(1) $\delta = 1$; DC
(2) $\delta = 0.5$; $f = 20\text{ kHz}$
(3) $\delta = 0.2$; $f = 20\text{ kHz}$
(4) $\delta = 0.1$; $f = 20\text{ kHz}$

Fig. 12. Average forward current as a function of solder point temperature; typical values

11. Test information

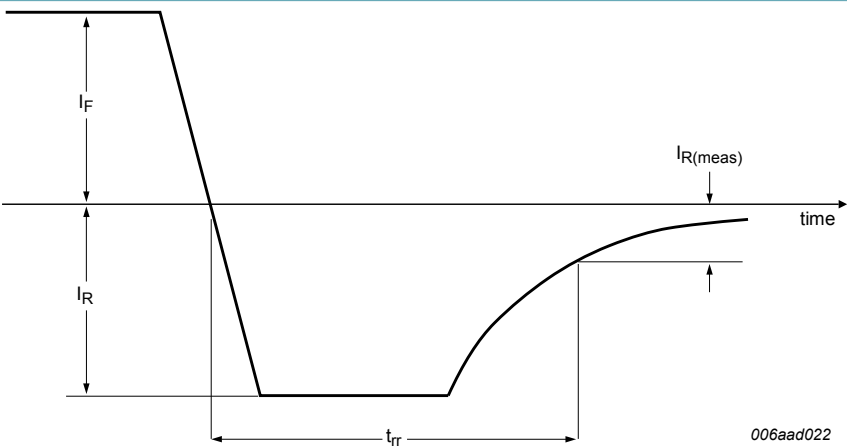


Fig. 13. Reverse recovery definition

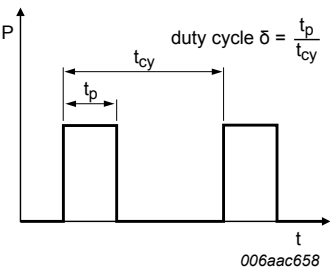


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:
 $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

12. Package outline

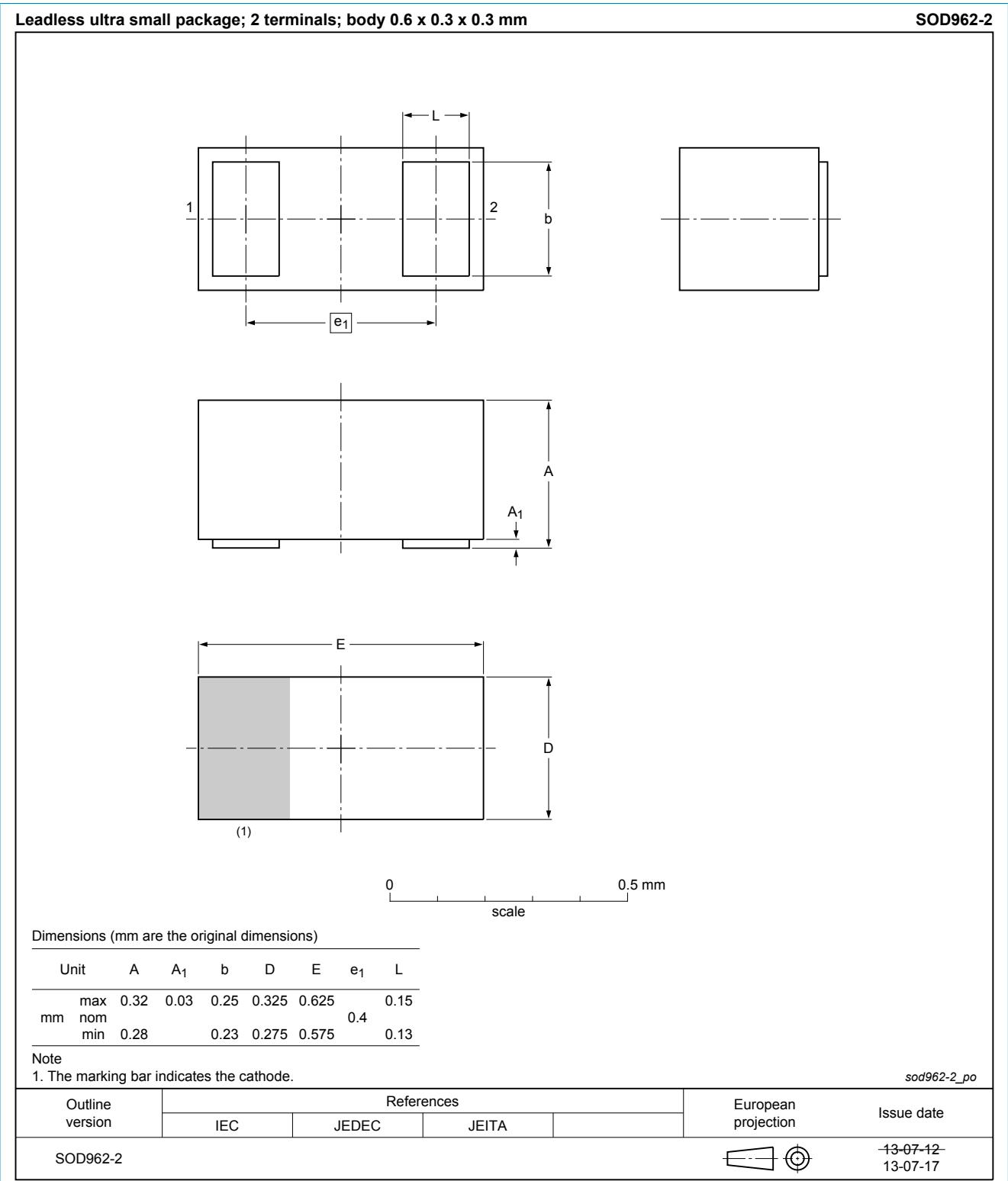
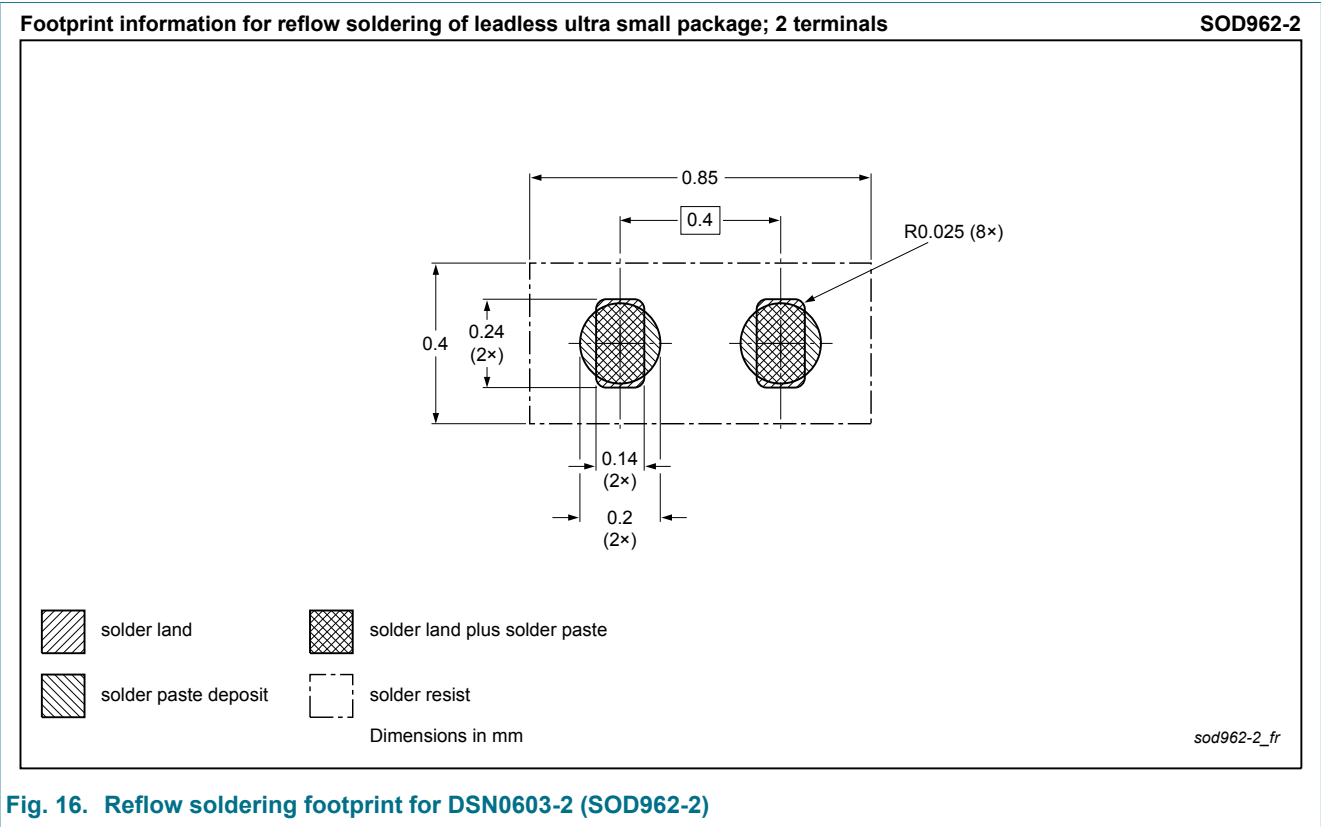


Fig. 15. Package outline DSN0603-2 (SOD962-2)

13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG4005AESF v.2	20150206	Product data sheet	-	PMEG4005AESF v.1
Modifications:	Product status changed			
PMEG4005AESF v.1	20140507	Preliminary data sheet	-	-

15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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